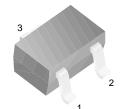


### FJX597JB

# Capacitor Microphone Applications • Especially Suited for use in Audio, Telephone Capacitor Microphones

- Excellent Voltage Characteristic
- Excellent Transient Characteristic



SOT-323 Marking: SCB 1. Drain 2. Source 3. Gate

### Si N-channel Junction FET

### **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{GDO}$	Gate-Drain Voltage	-20	V
I <sub>G</sub>	Gate Current	10	mA
I <sub>D</sub>	Drain Current	1	mA
P <sub>D</sub>	Power Dissipation	100	mW
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

### **Electrical Characteristics** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>GDO</sub>	Gate-Drain Breakdown Voltage	I <sub>G</sub> = -100uA	-20			V
V <sub>GS</sub> (off)	Gate-Source Cut-off Voltage	$V_{DS}$ =5V, $I_D$ =1 $\mu$ A		-0.6	-1.5	V
I <sub>DSS</sub>	Drain Current	$V_{DS}=5V, V_{GS}=0$	150		240	μΑ
IY <sub>FS</sub> I	Forward Transfer Admittance	$V_{DS}$ =5V, $V_{GS}$ =0, f=1MHz	0.4	1.2		mS
C <sub>ISS</sub>	Input Capacitance	$V_{DS}$ =5V, $V_{GS}$ =0, f=1MHz		3.5		pF
C <sub>RSS</sub>	Output Capacitance	$V_{DS}$ =5V, $V_{GS}$ =0, f=1MHz		0.65		pF

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## **Typical Characteristics**

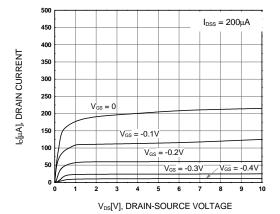


Figure 1. I<sub>D</sub>-V<sub>DS</sub>

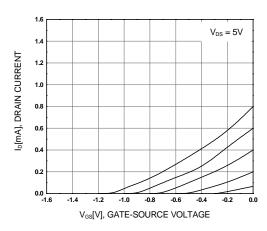


Figure 3. I<sub>D</sub>-V<sub>GS</sub>

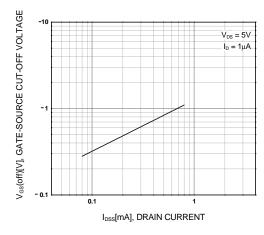


Figure 5.  $V_{GS}(off)$ - $I_{DSS}$ 

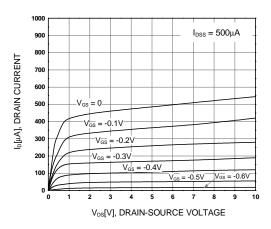


Figure 2. I<sub>D</sub>-V<sub>DS</sub>

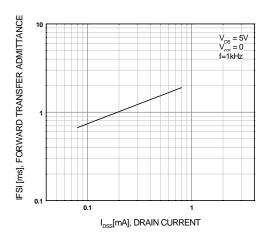


Figure 4. |y<sub>FS</sub>|-I<sub>DSS</sub>

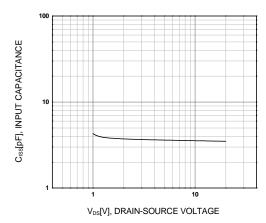


Figure 6.  $C_{ISS}$ - $V_{DS}$ 

## Typical Characteristics (Continued)

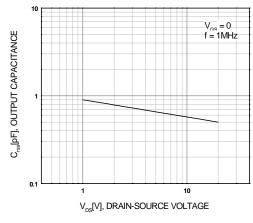


Figure 7.  $C_{RSS}$ - $V_{DS}$ 

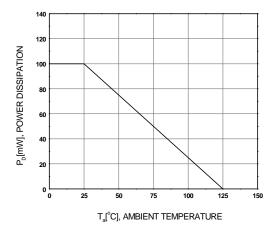
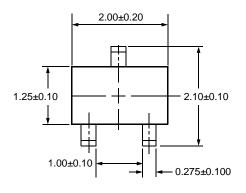
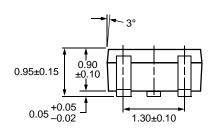


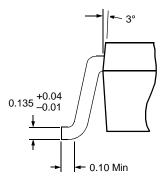
Figure 8. P<sub>D</sub>-T<sub>A</sub>

## **Package Dimensions**

## SOT-323







Dimensions in Millimeters

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$CROSSVOLT^{TM}$	GlobalOptoisolator™	MicroPak™	QFET <sup>®</sup>	SuperSOT™-8
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EnSigna™	i-Lo™	OCX™	RapidConfigure™	TruTranslation™
FACT™	ImpliedDisconnect™	OCXPro™	RapidConnect™	UHC™
FACT Quiet Series™		OPTOLOGIC <sup>®</sup>	μSerDes™	UltraFET <sup>®</sup>
Across the board. Around the world.™		OPTOPLANAR™	SILENT SWITCHER®	VCX <sup>TM</sup>
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